

**D3FK60****600V 2.1A****特長**

- 小型SMD
- 高耐圧
- $t_{rr} = 100\text{ns}$
- 低 $V_F$

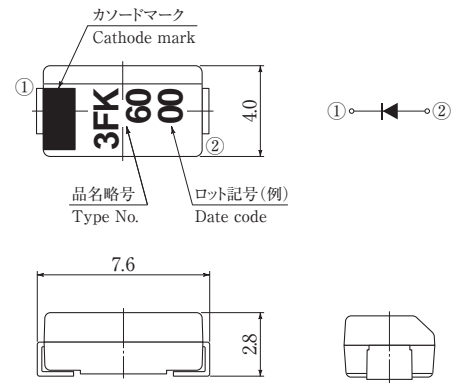
**Feature**

- Small SMD
- High Voltage
- $t_{rr}=100\text{ns}$
- Low  $V_F$

**■ 外観図 OUTLINE**

Package : 2F

Unit:mm



外形図については新電元Webサイトをご参照下さい。捺印表示については捺印仕様をご確認下さい。

For details of the outline dimensions, refer to our web site. As for the marking, refer to the specification "Marking, Terminal Connection".

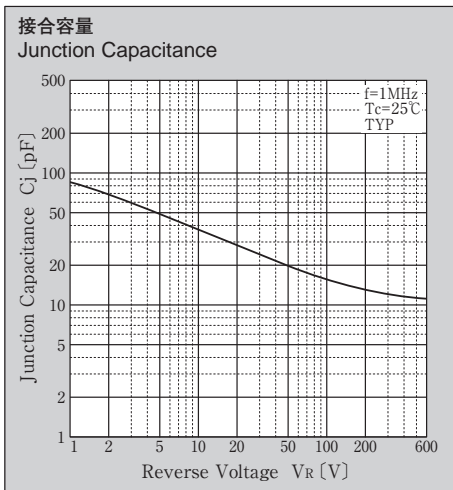
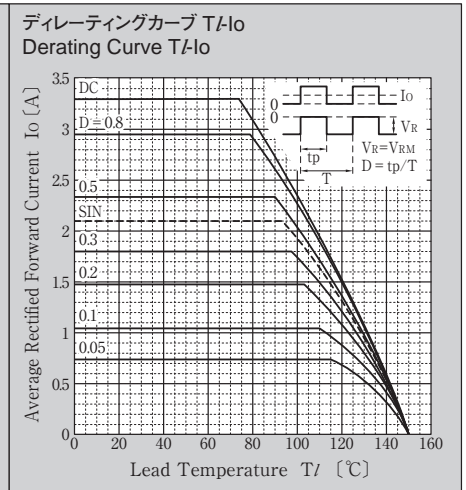
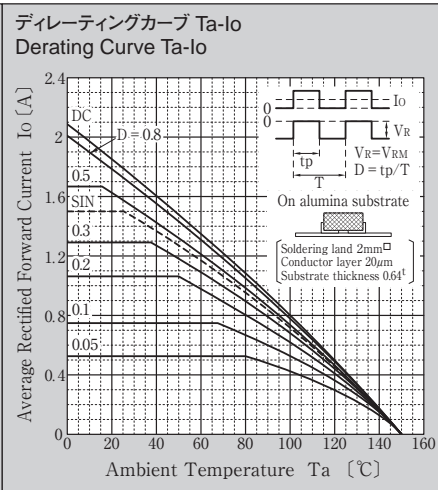
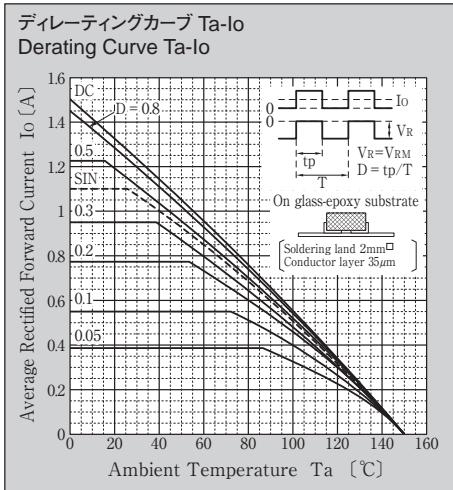
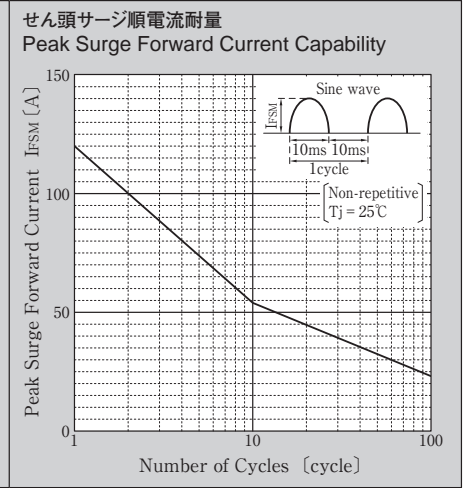
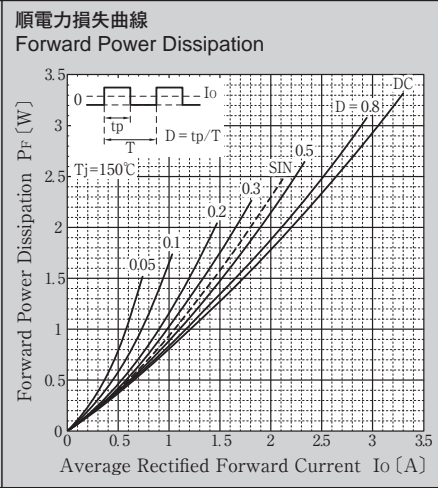
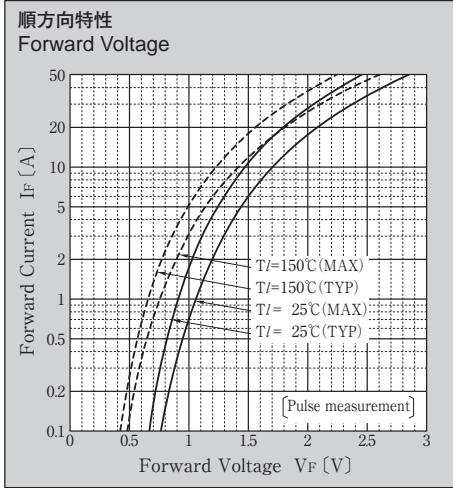
**■ 定格表 RATINGS****● 絶対最大定格 Absolute Maximum Ratings (指定のない場合  $T_I = 25^\circ\text{C}$ )**

項目 Item	記号 Symbol	条件 Conditions	規格値 Ratings	単位 Unit
保存温度 Storage Temperature	$T_{stg}$		- 55 ~ 150	$^\circ\text{C}$
接合部温度 Operation Junction Temperature	$T_j$		150	$^\circ\text{C}$
せん頭逆電圧 Maximum Reverse Voltage	$V_{RM}$		600	V
出力電流 Average Rectified Forward Current	$I_o$	50Hz 正弦波, 抵抗負荷, プリント基板実装 $T_a = 25^\circ\text{C}$ 50Hz sine wave, Resistance load, glass-epoxy substrate $T_a = 25^\circ\text{C}$	1.1	A
		50Hz 正弦波, 抵抗負荷, アルミナ基板実装 $T_a = 25^\circ\text{C}$ 50Hz sine wave, Resistance load, alumina substrate $T_a = 25^\circ\text{C}$	1.5	
		50Hz 正弦波, 抵抗負荷, $T_I = 93^\circ\text{C}$ 50Hz sine wave, Resistance load, $T_I = 93^\circ\text{C}$	2.1	
せん頭サーージ順電流 Peak Surge Forward Current	$I_{FSM}$	50Hz 正弦波, 非繰り返し1サイクルせん頭値, $T_j = 25^\circ\text{C}$ 50Hz sine wave, Non-repetitive 1 cycle peak value, $T_j = 25^\circ\text{C}$	120	A
電流二乗時間積 Current Squared Time	$I^2t$	$1\text{ms} \leq t < 10\text{ms}$ , $T_j = 25^\circ\text{C}$	72	$\text{A}^2\text{s}$

**● 電氣的・熱的特性 Electrical Characteristics (指定のない場合  $T_I = 25^\circ\text{C}$ )**

順電圧 Forward Voltage	$V_F$	$I_F = 2.1\text{A}$ , パルス測定 Pulse measurement	MAX 1.2	V
逆電流 Reverse Current	$I_R$	$V_R = 600\text{V}$ , パルス測定 Pulse measurement	MAX 10	$\mu\text{A}$
逆回復時間 Reverse Recovery Time	$t_{rr}$	$I_F = 0.5\text{A}$ , $I_R = 1\text{A}$ , $0.25 I_R$	MAX 100	ns
接合容量 Junction Capacitance	$C_j$	$f = 1\text{MHz}$ , $V_R = 10\text{V}$	TYP 37	pF
熱抵抗 Thermal Resistance	$\theta_{jl}$	接合部・リード間 Junction to lead	MAX 23	$^\circ\text{C}/\text{W}$
	$\theta_{ja}$	接合部・周囲間, アルミナ基板実装 Junction to ambient, alumina substrate	MAX 80	
		接合部・周囲間, プリント基板実装 Junction to ambient, glass-epoxy substrate	MAX 115	

■特性図 CHARACTERISTIC DIAGRAMS



\* Sine waveは50Hzで測定しています。  
 \* 50Hz sine wave is used for measurements.